

## PATENT ASSIGNMENT COVER SHEET

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Invention Title: Nano-Scale Metal-Insulator-Metal (MIM) Junction Realization Through Conventional UV Photolithography and Wafer Polishing Techniques

Inventor(s): I-Tsang Wu, Jing Wang

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The invention identified above is a Subject Invention under 35 U.S.C. 200, et seq., and the Standard Patent Rights clause at 37 CFR 401.14, FAR 52.227-11 or FAR 52.227-12 (if applicable) which are included among the terms of the above identified grant or contract award from the United States Government. This document is confirmatory of:

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Signed this 19 day of October, 20 16.

By Rebecca Puig, Ph.D.  
(Institutional Business Official)

Rebecca Puig  
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